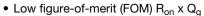


#### LSH60R380E-VB Datasheet

## N-Channel 600V (D-S) Super Junction Power MOSFET

| PRODUCT SUMMARY                            |                             |  |  |  |  |
|--|-----------------------------|--|--|--|--|
| V <sub>DS</sub> (V) at T <sub>J</sub> max. | 600                         |  |  |  |  |
| R <sub>DS(on)</sub> at 25 °C (Ω)           | V <sub>GS</sub> = 10 V 0.38 |  |  |  |  |
| Q <sub>g</sub> max. (nC)                   | 38                          |  |  |  |  |
| Q <sub>gs</sub> (nC)                       | 4                           |  |  |  |  |
| Q <sub>gd</sub> (nC)                       | 4.2                         |  |  |  |  |
| Configuration                              | Single                      |  |  |  |  |

#### **FEATURES**

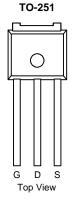


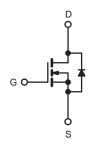


- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial





N-Channel MOSFET

| <b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted) |                         |   |                                   |              |      |  |
|--|-------------------------|---|-----------------------------------|--------------|------|--|
| PARAMETER  |                         |   | SYMBOL                            | LIMIT        | UNIT |  |
| Drain-Source Voltage   |                         |   | V <sub>DS</sub>                   | 600          | V    |  |
| Gate-Source Voltage  |                         |   | $V_{GS}$                          | ± 30         | v    |  |
| Continuous Drain Current (T <sub>.I</sub> = 150 °C)                              | \/ at 10 \/             | 10 V $\frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$ |                                   | 11           |      |  |
| Continuous Drain Current (1 <sub>J</sub> = 150 °C)                               | V <sub>GS</sub> at 10 V |   | l <sub>D</sub>                    | 6.7          | Α    |  |
| Pulsed Drain Current <sup>a</sup>  |                         |   | I <sub>DM</sub>                   | 30           |      |  |
| Linear Derating Factor   |                         |   |                                   | 1.67/1.5/0.3 | W/°C |  |
| Single Pulse Avalanche Energy b  |                         |   | E <sub>AS</sub>                   | 132          | mJ   |  |
| Maximum Power Dissipation  |                         |   | $P_{D}$                           | 83/83/31     | W    |  |
| Operating Junction and Storage Temperature Range                                 |                         |   | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150  | °C   |  |
| Drain-Source Voltage Slope T <sub>J</sub> = 125 °C                               |                         | dV/dt   | 50                                | V/ns         |      |  |
| Reverse Diode dV/dt <sup>d</sup>   |                         |   | 3.1                               | V/IIS        |      |  |
| Soldering Recommendations (Peak Temperature) c for 10 s                          |                         |   | 300                               | °C           |      |  |

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}=50$  V, starting  $T_J=25$  °C, L=28.2 mH,  $R_g=25$   $\Omega$ ,  $I_{AS}=4.5$  A. c. 1.6 mm from case.
- d.  $I_{SD} \le I_D$ , dI/dt = 100 A/ $\mu$ s, starting  $T_J = 25$  °C.

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| THERMAL RESISTANCE RATINGS       |                   |      |      |      |  |  |
|----------------------------------|-------------------|------|------|------|--|--|
| PARAMETER                        | SYMBOL            | TYP. | MAX. | UNIT |  |  |
| Maximum Junction-to-Ambient      | R <sub>thJA</sub> | -    | 80   | °C/W |  |  |
| Maximum Junction-to-Case (Drain) | $R_{thJC}$        | -    | 0.6  | C/VV |  |  |

| PARAMETER   | SYMBOL                | TEST CONDITIONS  |  | MIN. | TYP. | MAX.  | UNIT |
|---|-----------------------|--|--|------|------|-------|------|
| Static  |                       | •  |  | •    |      | •     |      |
| Drain-Source Breakdown Voltage                            | V <sub>DS</sub>       | V <sub>GS</sub> :  | = 0 V, I <sub>D</sub> = 250 μA   | 600  | -    | -     | V    |
| V <sub>DS</sub> Temperature Coefficient                   | $\Delta V_{DS}/T_{J}$ | Reference to 25 °C, I <sub>D</sub> = 1 mA  |  | -    | 0.65 | -     | V/°C |
| Gate-Source Threshold Voltage (N)                         | V <sub>GS(th)</sub>   | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$   |  | 2    | -    | 4     | V    |
|   |                       | $V_{GS} = \pm 20 \text{ V}$  |  | -    | -    | ± 100 | nA   |
| Gate-Source Leakage                                       | I <sub>GSS</sub>      |  | V <sub>GS</sub> = ± 30 V   |      | -    | ± 1   | μΑ   |
|   |                       | V <sub>DS</sub> =  | V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V   |      | -    | 1     |      |
| Zero Gate Voltage Drain Current                           | I <sub>DSS</sub>      |  | /, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C  | -    | -    | 10    | μA   |
| Drain-Source On-State Resistance                          | R <sub>DS(on)</sub>   | V <sub>GS</sub> = 10 V   | I <sub>D</sub> = 5 A   | -    | 0.38 | -     | Ω    |
| Forward Transconductance                                  | 9fs                   | V <sub>DS</sub>  | s = 30 V, I <sub>D</sub> = 5 A   | -    | 16   | -     | S    |
| Dynamic   |                       |  |  | •    | •    | •     |      |
| Input Capacitance   | C <sub>iss</sub>      |  | V <sub>GS</sub> = 0 V,   | -    | 680  | -     |      |
| Output Capacitance  | C <sub>oss</sub>      | 1  | $V_{DS} = 100 \text{ V},$  | -    | 140  | -     | 1    |
| Reverse Transfer Capacitance                              | C <sub>rss</sub>      | 7  | f = 1 MHz  |      | 5    | -     | pF   |
| Effective Output Capacitance, Energy Related <sup>a</sup> | C <sub>o(er)</sub>    |  |  | -    | 63   | -     |      |
| Effective Output Capacitance, Time Related <sup>b</sup>   | C <sub>o(tr)</sub>    | $V_{DS} = 0.0$   | $V_{DS} = 0 \text{ V to } 520 \text{ V}, V_{GS} = 0 \text{ V}$                             |      | 113  | -     |      |
| Total Gate Charge   | Qg                    |  |  | -    | 38   | 56    |      |
| Gate-Source Charge  | Q <sub>gs</sub>       | $V_{GS} = 10 \text{ V}$ $I_D = 5 \text{ A}, V_{DS} = 520 \text{ V}$                                |  | -    | 4    | -     | nC   |
| Gate-Drain Charge   | Q <sub>gd</sub>       |  |  | -    | 4.5  | -     | 1    |
| Turn-On Delay Time  | t <sub>d(on)</sub>    | V <sub>DD</sub> = 520 V, I <sub>D</sub> = 5 A,   |  | -    | 13   | 25    |      |
| Rise Time   | t <sub>r</sub>        |  |  | -    | 11   | 35    | nc   |
| Turn-Off Delay Time                                       | t <sub>d(off)</sub>   |  | $V_{GS} = 320 \text{ V}, I_{D} = 3 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$ |      | 81   | 90    | ns   |
| Fall Time   | t <sub>f</sub>        |  |  |      | 25   | 40    |      |
| Gate Input Resistance                                     | $R_{g}$               | f = 1 MHz, open drain  |  | -    | 3.5  | -     | Ω    |
| <b>Drain-Source Body Diode Characteristic</b>             | S                     |  |  |      |      |       |      |
| Continuous Source-Drain Diode Current                     | I <sub>S</sub>        | MOSFET symbol showing the integral reverse p - n junction diode                                    |  | -    | -    | 11    | •    |
| Pulsed Diode Forward Current                              | I <sub>SM</sub>       |  |  | -    | -    | 30    | A A  |
| Diode Forward Voltage                                     | V <sub>SD</sub>       | T <sub>J</sub> = 25 °C, I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V                                |  | -    | -    | 1.5   | V    |
| Reverse Recovery Time                                     | t <sub>rr</sub>       | $T_J = 25 \text{ °C}, I_F = I_S = 5 \text{ A},$<br>$dI/dt = 100 \text{ A/µs}, V_R = 400 \text{ V}$ |  | -    | 270  | -     | ns   |
| Reverse Recovery Charge                                   | Q <sub>rr</sub>       |  |  | -    | 3.3  | -     | μC   |
| Reverse Recovery Current                                  | I <sub>RBM</sub>      |  |  | _    | 30   | _     | A    |

#### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

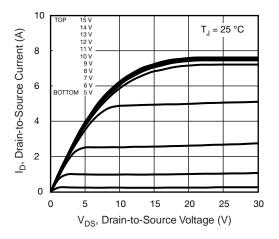


Fig. 1 - Typical Output Characteristics

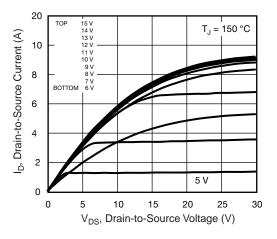


Fig. 2 - Typical Output Characteristics

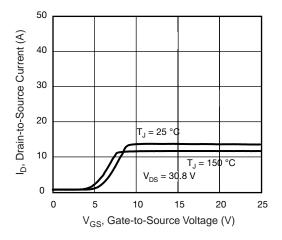


Fig. 3 - Typical Transfer Characteristics

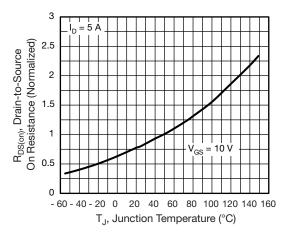


Fig. 4 - Normalized On-Resistance vs. Temperature

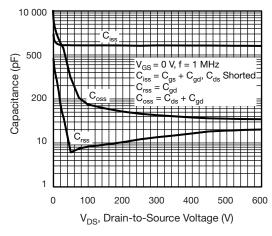


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

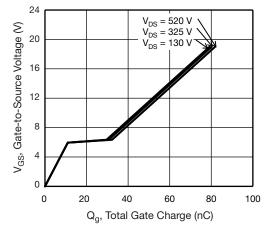


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



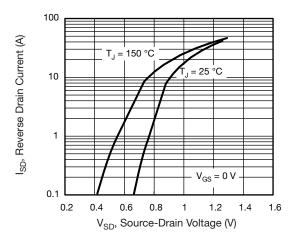


Fig. 7 - Typical Source-Drain Diode Forward Voltage

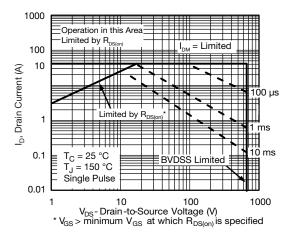


Fig. 8 - Maximum Safe Operating Area

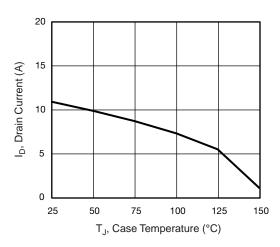


Fig. 9 - Maximum Drain Current vs. Case Temperature

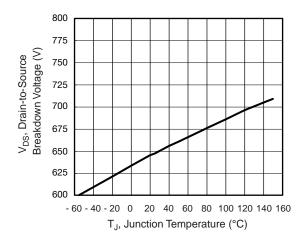


Fig. 10 - Temperature vs. Drain-to-Source Voltage

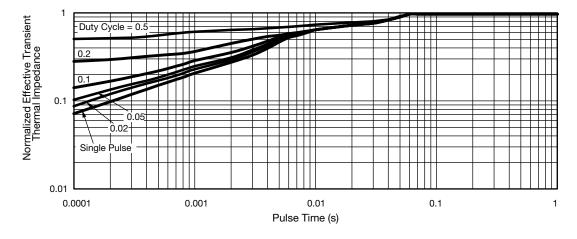


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

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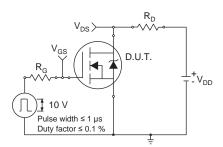


Fig. 12 - Switching Time Test Circuit

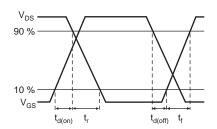


Fig. 13 - Switching Time Waveforms

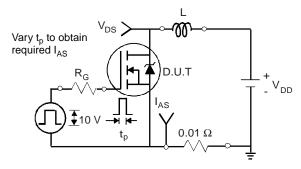


Fig. 14 - Unclamped Inductive Test Circuit

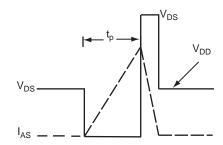


Fig. 15 - Unclamped Inductive Waveforms

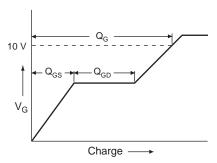


Fig. 16 - Basic Gate Charge Waveform

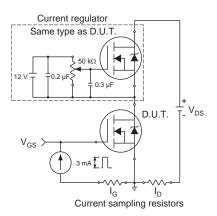
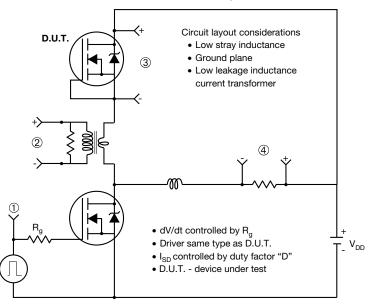


Fig. 17 - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



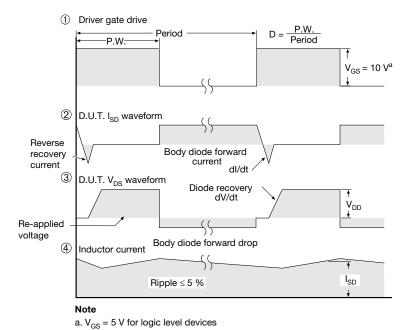
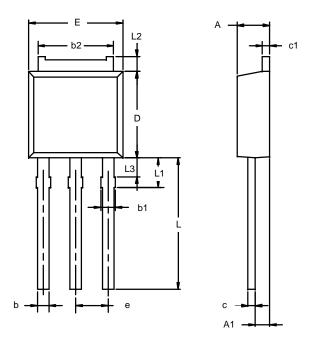


Fig. 18 - For N-Channel

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### TO-251AA (DPAK)



|              | MILLIM | IETERS | INCHES |       |  |  |
|--------------|--------|--------|--------|-------|--|--|
| Dim          | Min    | Max    | Min    | Max   |  |  |
| Α            | 2.21   | 2.38   | 0.087  | 0.094 |  |  |
| <b>A</b> 1   | 0.89   | 1.14   | 0.035  | 0.045 |  |  |
| b            | 0.71   | 0.89   | 0.028  | 0.035 |  |  |
| b1           | 0.76   | 1.14   | 0.030  | 0.045 |  |  |
| b2           | 5.23   | 5.43   | 0.206  | 0.214 |  |  |
| С            | 0.46   | 0.58   | 0.018  | 0.023 |  |  |
| с1           | 0.46   | 0.58   | 0.018  | 0.023 |  |  |
| D            | 5.97   | 6.22   | 0.235  | 0.245 |  |  |
| Е            | 6.48   | 6.73   | 0.255  | 0.265 |  |  |
| е            | 2.28   | BSC    | 0.090  | BSC   |  |  |
| L            | 8.89   | 9.53   | 0.350  | 0.375 |  |  |
| L1           | 1.91   | 2.28   | 0.075  | 0.090 |  |  |
| L2           | 0.89   | 1.27   | 0.035  | 0.050 |  |  |
| L3           | 1.15   | 1.52   | 0.045  | 0.060 |  |  |
| ECN: S-03046 |        |        |        |       |  |  |

ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346

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